

International **IR** Rectifier

PD-95435

IRL3103D2PbF

FETKY™ MOSFET & SCHOTTKY RECTIFIER

- Copackaged HEXFET® Power MOSFET and Schottky Diode
- Generation 5 Technology
- Logic Level Gate Drive
- Minimize Circuit Inductance
- Ideal For Synchronous Regulator Application
- Lead-Free

Description

The FETKY family of copackaged HEXFET power MOSFETs and Schottky Diodes offer the designer an innovative board space saving solution for switching regulator applications. A low on resistance Gen 5 MOSFET with a low forward voltage drop Schottky diode and minimized component interconnect inductance and resistance result in maximized converter efficiencies.

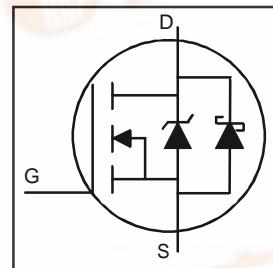
The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

Absolute Maximum Ratings

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	54	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	34	
I_{DM}	Pulsed Drain Current ①	220	
$P_D @ T_A = 25^\circ C$	Power Dissipation	2.0	W
$P_D @ T_C = 25^\circ C$	Power Dissipation	70	W
	Linear Derating Factor	0.56	W/°C
V_{GS}	Gate-to-Source Voltage	± 16	V
T_J	Operating Junction and	-55 to + 150	°C
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	°C
	Mounting torque, 6-32 or M3 screw	10 lbf·in (1.1N·m)	

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	---	1.8	°C/W
$R_{\theta JA}$	Junction-to-Ambient	---	62	



$V_{DSS} = 30V$
 $R_{DS(on)} = 0.014\Omega$
 $I_D = 54A$

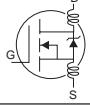


TO-220AB

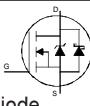
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MOSFET Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	30	---	---	V	$V_{\text{GS}} = 0\text{V}$, $I_D = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient	---	0.037	---	V/ $^\circ\text{C}$	Reference to 25°C , $I_D = 1\text{mA}$ ③
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-Resistance	---	---	0.014	Ω	$V_{\text{GS}} = 10\text{V}$, $I_D = 32\text{A}$ ②
		---	---	0.019		$V_{\text{GS}} = 4.5\text{V}$, $I_D = 27\text{A}$ ②
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	1.0	---	---	V	$V_{\text{DS}} = V_{\text{GS}}$, $I_D = 250\mu\text{A}$
g_{fs}	Forward Transconductance	23	---	---	S	$V_{\text{DS}} = 25\text{V}$, $I_D = 34\text{A}$ ③
I_{DSS}	Drain-to-Source Leakage Current	---	---	0.25	mA	$V_{\text{DS}} = 30\text{V}$, $V_{\text{GS}} = 0\text{V}$
		---	---	35		$V_{\text{DS}} = 24\text{V}$, $V_{\text{GS}} = 0\text{V}$, $T_J = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage	---	---	100	nA	$V_{\text{GS}} = 16\text{V}$
	Gate-to-Source Reverse Leakage	---	---	-100		$V_{\text{GS}} = -16\text{V}$
Q_g	Total Gate Charge	---	---	44	nC	$I_D = 32\text{A}$
Q_{gs}	Gate-to-Source Charge	---	---	14		$V_{\text{DS}} = 24\text{V}$
Q_{gd}	Gate-to-Drain ("Miller") Charge	---	---	24		$V_{\text{GS}} = 4.5\text{V}$, See Fig. 6 ②
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	---	9.0	---	ns	$V_{\text{DD}} = 15\text{V}$
t_r	Rise Time	---	210	---		$I_D = 34\text{A}$
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	---	20	---		$R_G = 3.4\Omega$, $V_{\text{GS}} = 4.5\text{V}$
t_f	Fall Time	---	54	---		$R_D = 0.43\Omega$, ②③
L_D	Internal Drain Inductance	---	4.5	---	nH	Between lead, 6mm (0.25in.) from package and center of die contact
L_S	Internal Source Inductance	---	7.5	---		
C_{iss}	Input Capacitance	---	2300	---	pF	$V_{\text{GS}} = 0\text{V}$
C_{oss}	Output Capacitance	---	1100	---		$V_{\text{DS}} = 25\text{V}$
C_{rss}	Reverse Transfer Capacitance	---	310	---		$f = 1.0\text{MHz}$, See Fig. 5
C_{iss}	Input Capacitance	---	3500	---		$V_{\text{GS}} = 0\text{V}$, $V_{\text{DS}} = 0\text{V}$

Body Diode & Schottky Diode Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_F (\text{AV})$	(Schottky)	---	---	5.0	A	MOSFET symbol showing the integral reverse p-n junction and Schottky diode. 
I_{SM}	Pulsed Source Current (Body Diode) ①	---	---	220		
$V_{\text{SD}1}$	Diode Forward Voltage	---	---	1.3	V	$T_J = 25^\circ\text{C}$, $I_S = 32\text{A}$, $V_{\text{GS}} = 0\text{V}$ ②
$V_{\text{SD}2}$	Diode Forward Voltage	---	---	0.6	V	$T_J = 25^\circ\text{C}$, $I_S = 3.0\text{A}$, $V_{\text{GS}} = 0\text{V}$ ②
t_{rr}	Reverse Recovery Time	---	51	77	ns	$T_J = 25^\circ\text{C}$, $I_F = 32\text{A}$ $dI/dt = 100\text{A}/\mu\text{s}$ ②
Q_{rr}	Reverse Recovery Charge	---	47	71	nC	
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L_S+L_D)				

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 10)
- ② Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.
- ③ Uses IRL3103 data and test conditions

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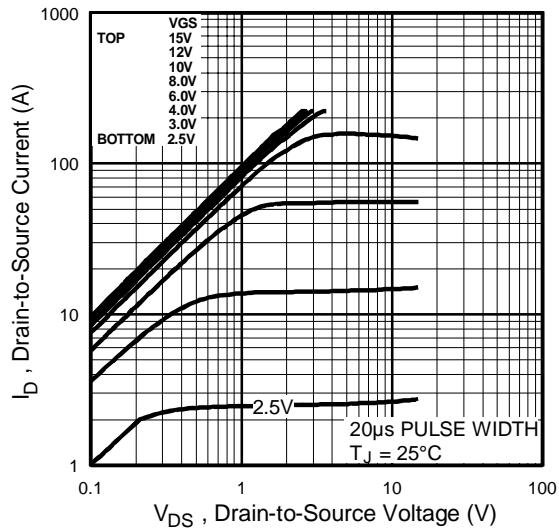


Fig 1. Typical Output Characteristics

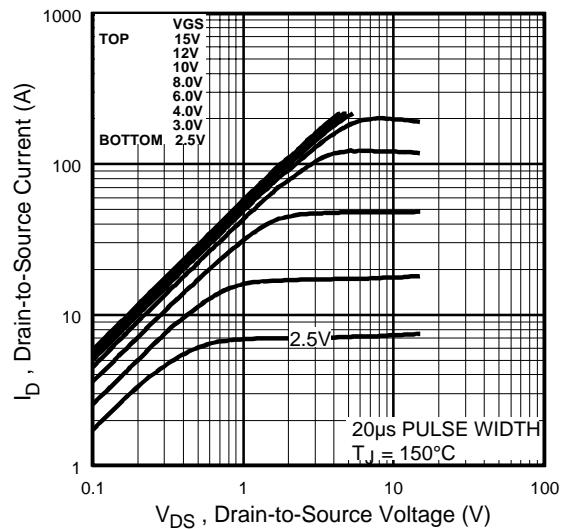


Fig 2. Typical Output Characteristics

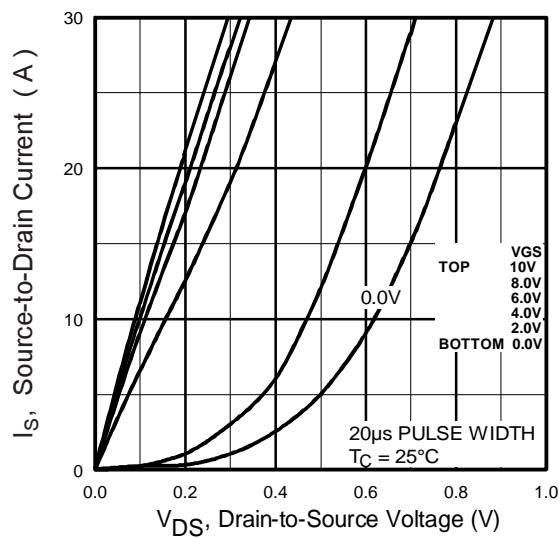


Fig 3. Typical Reverse Output Characteristics

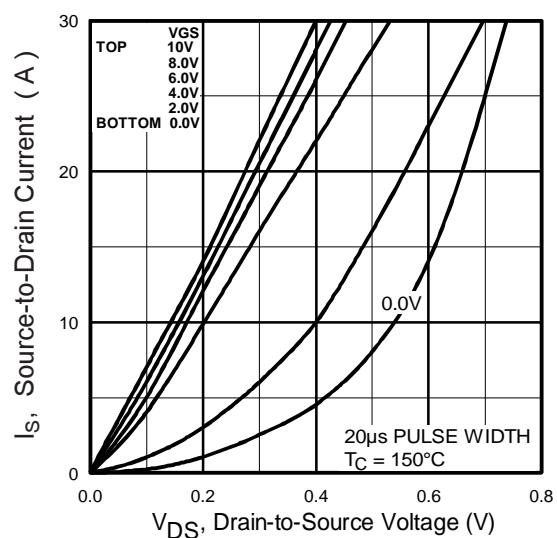


Fig 4. Typical Reverse Output Characteristics

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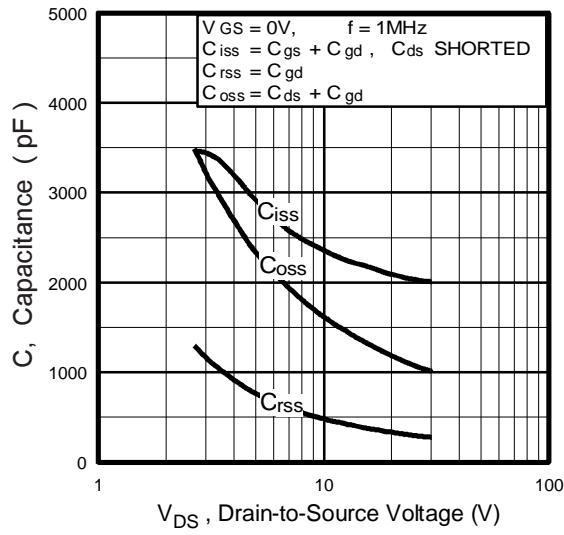


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

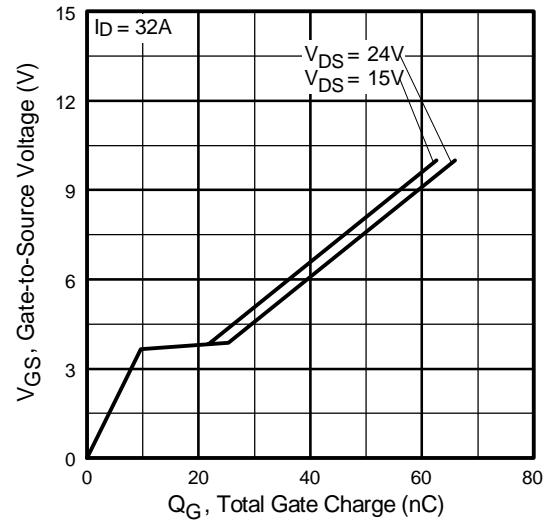


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

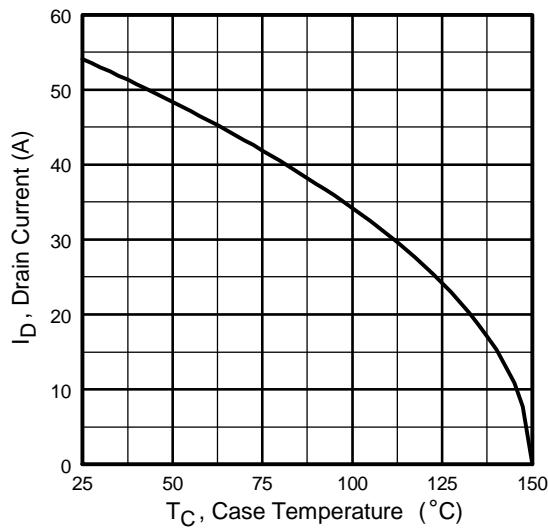


Fig 7. Maximum Drain Current Vs.
Case Temperature

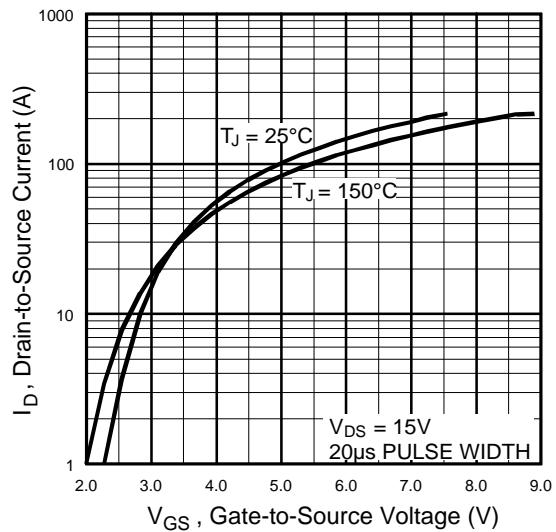


Fig 8. Typical Transfer Characteristics

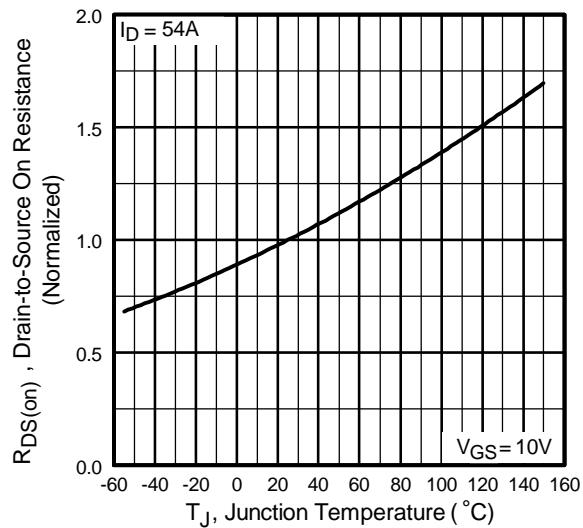


Fig 9. Normalized On-Resistance
Vs. Temperature

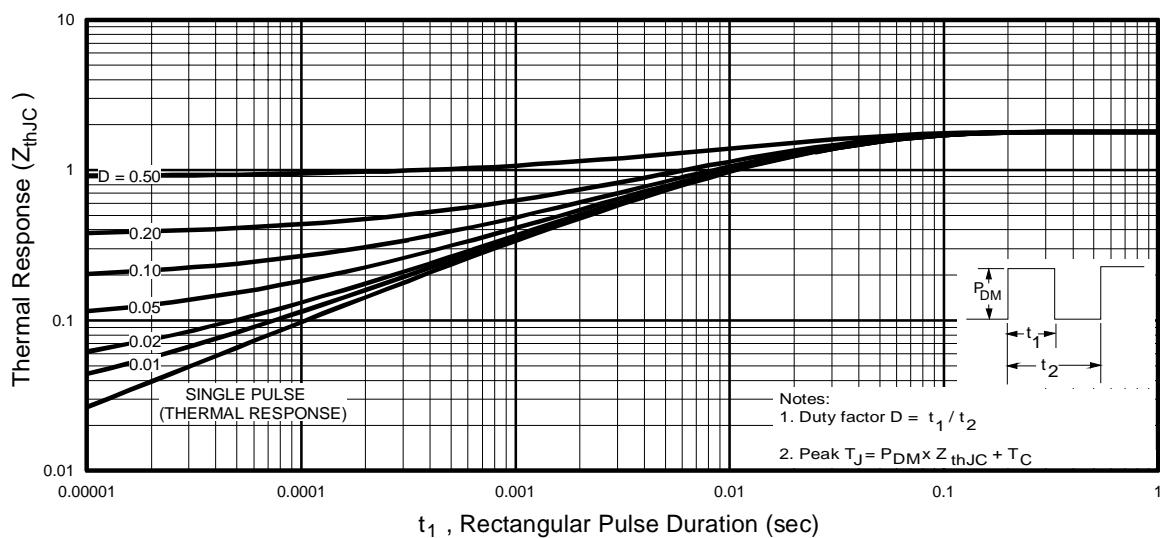


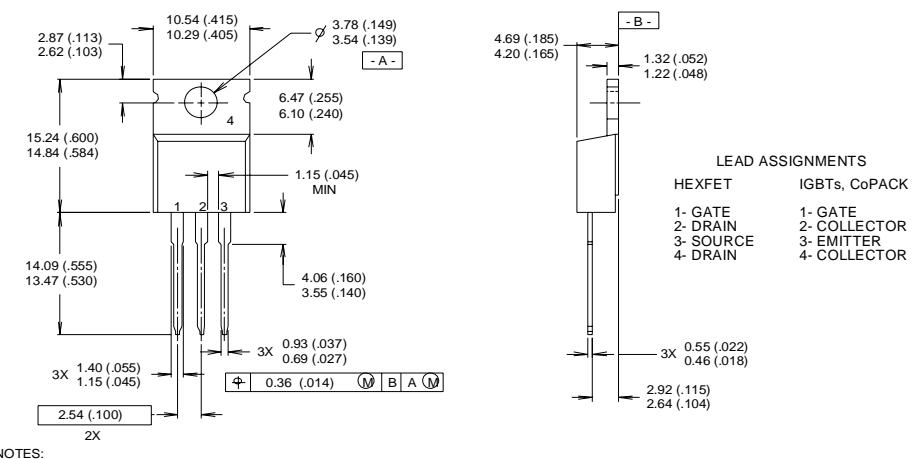
Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



NOTES:

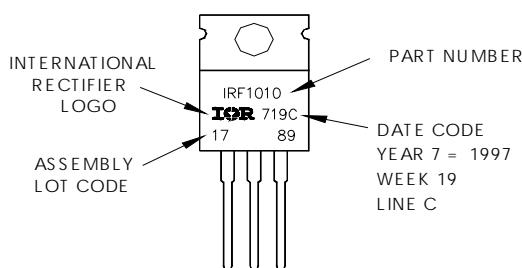
- 1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982.
- 2 CONTROLLING DIMENSION : INCH

3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB.

4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010
LOT CODE 1789
ASSEMBLED ON WW 19, 1997
IN THE ASSEMBLY LINE "C"
Note: "P" in assembly line
position indicates "Lead-Free"



Data and specifications subject to change without notice.

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Visit us at www.irf.com for sales contact information. 06/04

Note: For the most current drawings please refer to the IR website at:
<http://www.irf.com/package/>